General Description
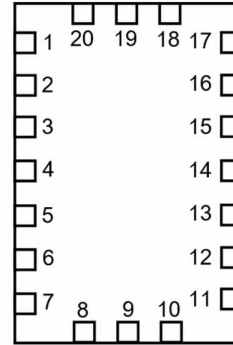
Renesas SLG7RN45294 is a low power and small form device. The SoC is housed in a 2mm x 3mm STQFN package which is optimal for using with small devices.

Features

- Low Power Consumption
- Pb - Free / RoHS Compliant
- Halogen - Free
- STQFN - 20 Package

Output Summary

3 Outputs - Open Drain NMOS 1X
5 Outputs - Push Pull 1X

Pin Configuration

STQFN-20
(Top View)

Pin name

Pin #	Pin name	Pin #	Pin name
1	VDD	11	GND
2	RZ_RSPI1_SSL	12	CAN1_RX
3	RZ_RSPI1_CK	13	CAN1_TX
4	RZ_RSPI1_MISO	14	VDD2
5	RZ_RSPI1_MOSI	15	CAN0_RX
6	RZ_CAN0_TX	16	CAN0_TX
7	RZ_CAN0_RX	17	SPI1_DO
8	RZ_CAN1_TX	18	SPI1_DIN
9	NC	19	SPI1_CK
10	RZ_CAN1_RX	20	SPI1_CS0#

Block Diagram
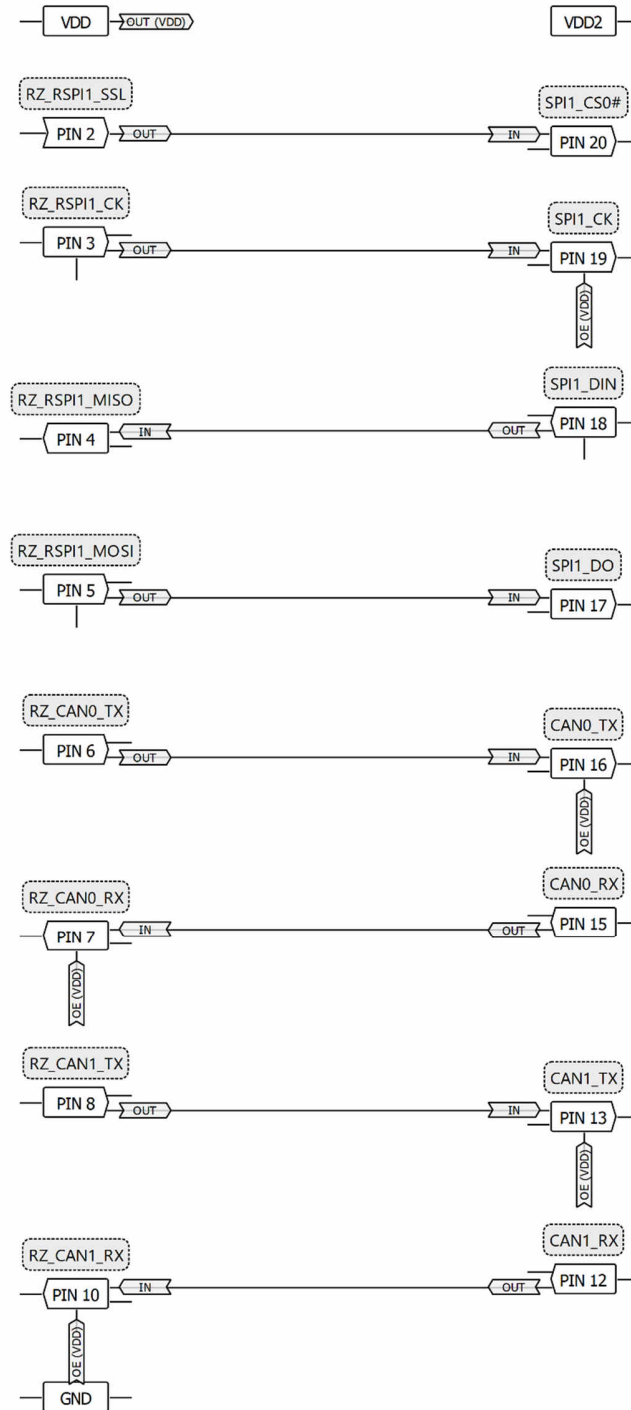
Pin Configuration

Pin #	Pin Name	Type	Pin Description	Internal Resistor
1	VDD	PWR	Supply Voltage	--
2	RZ_RSPI1_SSL	Digital Input	Digital Input with Schmitt trigger	floating
3	RZ_RSPI1_CK	Digital Input	Digital Input with Schmitt trigger	floating
4	RZ_RSPI1_MISO	Digital Output	Open Drain NMOS 1X	floating
5	RZ_RSPI1_MOSI	Digital Input	Digital Input with Schmitt trigger	floating
6	RZ_CAN0_TX	Digital Input	Digital Input with Schmitt trigger	floating
7	RZ_CAN0_RX	Digital Output	Open Drain NMOS 1X	floating
8	RZ_CAN1_TX	Digital Input	Digital Input with Schmitt trigger	floating
9	NC	--	Keep Floating or Connect to GND	--
10	RZ_CAN1_RX	Digital Output	Open Drain NMOS 1X	floating
11	GND	GND	Ground	--
12	CAN1_RX	Digital Input	Digital Input with Schmitt trigger	floating
13	CAN1_TX	Digital Output	Push Pull 1X	floating
14	VDD2	PWR	Supply Voltage	--
15	CAN0_RX	Digital Input	Digital Input with Schmitt trigger	floating
16	CAN0_TX	Digital Output	Push Pull 1X	floating
17	SPI1_DO	Digital Output	Push Pull 1X	floating
18	SPI1_DIN	Digital Input	Digital Input with Schmitt trigger	floating
19	SPI1_CK	Digital Output	Push Pull 1X	floating
20	SPI1_CS0#	Digital Output	Push Pull 1X	floating

Ordering Information

Part Number	Package Type
SLG7RN45294V	20-pin STQFN - Tape and Reel (3k units)

Absolute Maximum Conditions

Parameter		Min.	Max.	Unit
Supply Voltage on VDD relative to GND		-0.5	7	V
Supply voltage on VDD2 relative to GND		-0.5	VDD + 0.5	V
DC Input voltage	PINs 2, 3, 4, 5, 6, 7, 8, 9, 10	GND - 0.5	VDD + 0.5	V
	PINs 12, 13, 15, 16, 17, 18, 19, 20		VDD2 + 0.5	
Maximum Average or DC Current (Through pin)	Push-Pull 1x	--	11	mA
	OD 1x	--	11	
Current at Input Pin		-1.0	1.0	mA
Input leakage (Absolute Value)		--	1000	nA
Storage Temperature Range		-65	150	°C
Junction Temperature		--	150	°C
ESD Protection (Human Body Model)		2000	--	V
ESD Protection (Charged Device Model)		500	--	V
Moisture Sensitivity Level		1		

Electrical Characteristics

Symbol	Parameter	Condition/Note	Min.	Typ.	Max.	Unit
V_{DD}	Supply Voltage		4.7	5	5.5	V
V_{DD2}	Supply Voltage		1.71	1.8	5.5	V
T_A	Operating Temperature		-40	25	85	°C
C_{VDD}	Capacitor Value at VDD		--	0.1	--	µF
C_{IN}	Input Capacitance		--	4	--	pF
I_Q	Quiescent Current	Static inputs and floating outputs	--	1	--	µA
V_O	Maximal Voltage Applied to any PIN in High-Impedance State		--	--	VDD	V
I_{VDD}	Maximum Average or DC Current Through VDD Pin (Per chip side, see Note 2)	T_J = 85°C	--	--	45	mA
		T_J = 110°C	--	--	22	mA
I_{GND}	Maximum Average or DC Current Through GND Pin (Per chip side, see Note 2)	T_J = 85°C	--	--	86	mA
		T_J = 110°C	--	--	41	mA
V_{IH}	HIGH-Level Input Voltage PINs 2, 3, 4, 5, 6, 7, 8, 9 and 10	Logic Input with Schmitt Trigger at VDD=5.0V	3.34	--	VDD	V
V_{IH2}	HIGH-Level Input Voltage PINs 12, 13, 15, 16, 17, 18, 19, 20	Logic Input with Schmitt Trigger at VDD2=1.8V	1.28	--	VDD	V
		Logic Input with Schmitt Trigger at VDD2=3.3V	2.14	--	VDD	V
		Logic Input with Schmitt Trigger at VDD2=5.0V	3.34	--	VDD	V
V_{IL}	LOW-Level Input Voltage PINs 2, 3, 4, 5, 6, 7, 8, 9 and 10	Logic Input with Schmitt Trigger at VDD=5.0V	0	--	1.41	V
V_{IL2}	LOW-Level Input Voltage PINs 12, 13, 15, 16, 17, 18, 19, 20	Logic Input with Schmitt Trigger at VDD2=1.8V	0	--	0.49	V
		Logic Input with Schmitt Trigger at VDD2=3.3V	0	--	0.97	V

		Logic Input with Schmitt Trigger at VDD2=5.0V	0	--	1.41	V
V_{OH2}	HIGH-Level Output Voltage PINs 12, 13, 15, 16, 17, 18, 19, 20	Push-Pull 1X, I_{OH}=100µA at VDD2=1.8V	1.69	1.79	--	V
		Push-Pull 1X, I_{OH}=3mA at VDD2=3.3V	2.74	3.12	--	V
		Push-Pull 1X, I_{OH}=5mA at VDD2=5.0V	4.15	4.76	--	V
V_{OL}	LOW-Level Output Voltage PINs 2, 3, 4, 5, 6, 7, 8, 9 and 10	Open Drain NMOS 1X, I_{OL}=5mA at VDD=5.0V	--	0.12	0.16	V
V_{OL2}	LOW-Level Output Voltage PINs 12, 13, 15, 16, 17, 18, 19, 20	Push-Pull 1X, I_{OL}=100µA at VDD2=1.8V	--	0.01	0.03	V
		Push-Pull 1X, I_{OL}=3mA at VDD2=3.3V	--	0.13	0.23	V
		Push-Pull 1X, I_{OL}=5mA at VDD2=5.0V	--	0.19	0.24	V
I_{OH2}	HIGH-Level Output Current (see Note 1) PINs 12, 13, 15, 16, 17, 18, 19, 20	Push-Pull 1X, V_{OH}=VDD-0.2V at VDD2=1.8V	1.07	1.70	--	mA
		Push-Pull 1X, V_{OH}=2.4V at VDD2=3.3V	6.05	12.08	--	mA
		Push-Pull 1X, V_{OH}=2.4V at VDD2=5.0V	22.08	34.04	--	mA
I_{OL}	LOW-Level Output Current (see Note 1) PINs 2, 3, 4, 5, 6, 7, 8, 9 and 10	Open Drain NMOS 1X, V_{OL}=0.4V at VDD=5.0V	10.82	17.38	--	mA
I_{OL2}	LOW-Level Output Current (see Note 1) PINs 12, 13, 15, 16, 17, 18, 19, 20	Push-Pull 1X, V_{OL}=0.15V at VDD2=1.8V	0.92	1.69	--	mA
		Push-Pull 1X, V_{OL}=0.4V at VDD2=3.3V	4.88	8.24	--	mA
		Push-Pull 1X, V_{OL}=0.4V at VDD2=5.0V	7.22	11.58	--	mA
T_{SU}	Startup Time	From VDD rising past PON_{THR}	0.61	1.24	1.65	ms
PON_{THR}	Power On Threshold	V_{DD} Level Required to Start Up the Chip	1.41	1.54	1.66	V
$POFF_{THR}$	Power Off Threshold	V_{DD} Level Required to Switch Off the Chip	1.00	1.15	1.31	V

Note:
1. DC or average current through any pin should not exceed value given in Absolute Maximum Conditions.
2. The GreenPAK's power rails are divided in two sides. PINs 2, 3, 4, 5, 6, 7, 8, 9 and 10 are connected to one side, PINs 12, 13, 15, 16, 17, 18, 19, and 20 to another.
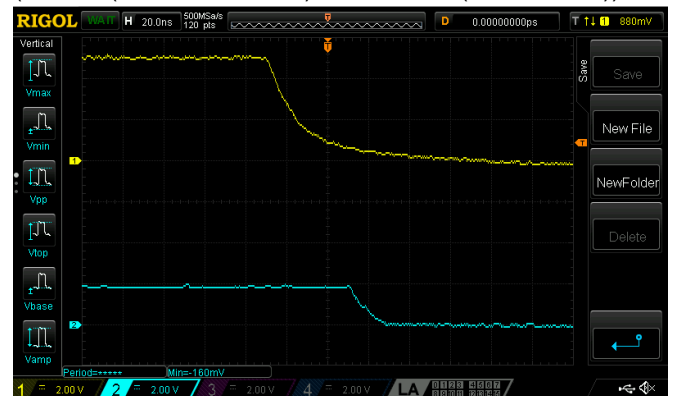3. Guaranteed by Design.

Functionality Waveforms

Channel 1 (yellow/top line) – PIN# 2 (RZ_RSPI1_SSL)
Channel 2 (light blue/2nd line) – PIN# 20 (SPI1_CS0#)

1. Transient from Low to High
(PIN# 2 (RZ_RSPI1_SSL) => PIN# 20 (SPI1_CS0#))

2. Transient from High to Low
(PIN# 2 (RZ_RSPI1_SSL) => PIN# 20 (SPI1_CS0#))

Channel 1 (yellow/top line) – PIN# 3 (RZ_RSPI1_CK)
Channel 2 (light blue/2nd line) – PIN# 19 (SPI1_CK)

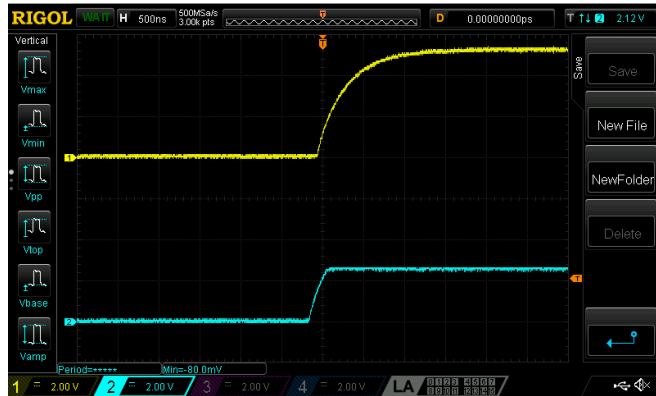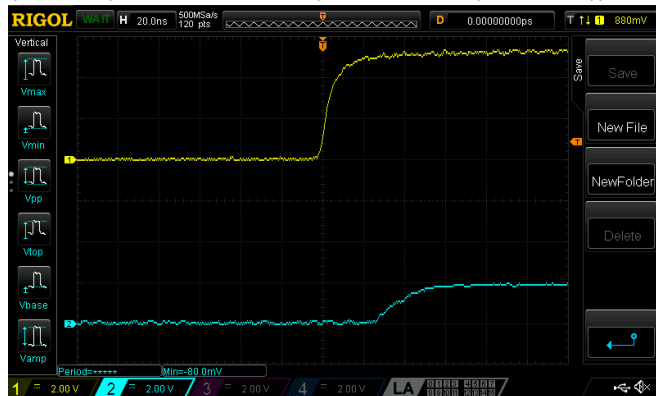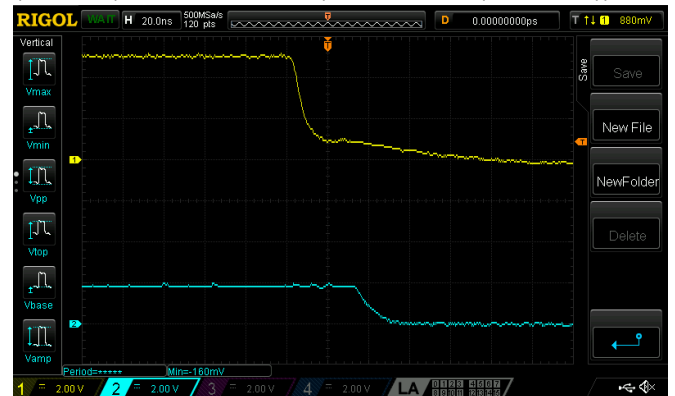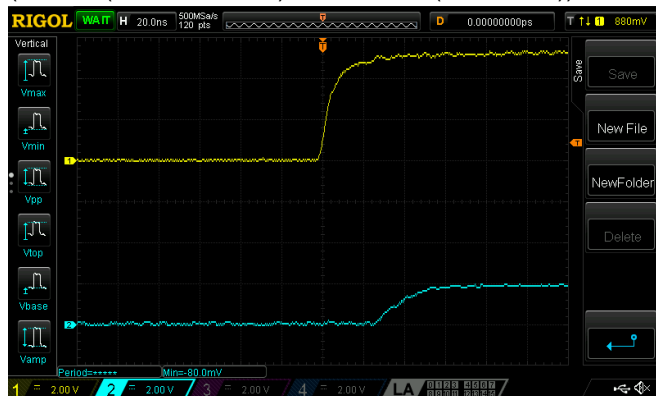3. Transient from Low to High
(PIN# 3 (RZ_RSPI1_CK) => PIN# 19 (SPI1_CK))

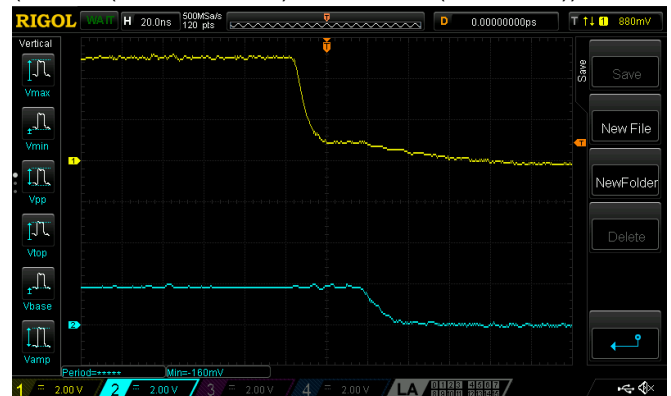4. Transient from High to Low
(PIN# 3 (RZ_RSPI1_CK) => PIN# 19 (SPI1_CK))

Channel 1 (yellow/top line) – PIN# 4 (RZ_RSPI1_MISO) with external 5kΩ pull up resistor
Channel 2 (light blue/2nd line) – PIN# 18 (SPI1_DIN)

5. Transient from Low to High
(PIN# 18 (SPI1_DIN) => PIN# 4 (RZ_RSPI1_MISO))

6. Transient from High to Low
(PIN# 18 (SPI1_DIN) => PIN# 4 (RZ_RSPI1_MISO))

Channel 1 (yellow/top line) – PIN# 5 (RZ_RSPI1_MOSI)
Channel 2 (light blue/2nd line) – PIN# 17 (SPI1_DO)

7. Transient from Low to High
(PIN# 5 (RZ_RSPI1_MOSI) => PIN# 17 (SPI1_DO))

8. Transient from High to Low
(PIN# 5 (RZ_RSPI1_MOSI) => PIN# 17 (SPI1_DO))

SLG7RN45294_DS_r011
SLG7RN45294_GP_r001

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Rev 0.11
Revised July 11, 2023

Channel 1 (yellow/top line) – PIN# 6 (RZ_CAN0_TX)
Channel 2 (light blue/2nd line) – PIN# 16 (CAN0_TX)

9. Transient from Low to High
(PIN# 6 (RZ_CAN0_TX) => PIN# 16 (CAN0_TX))

10. Transient from High to Low
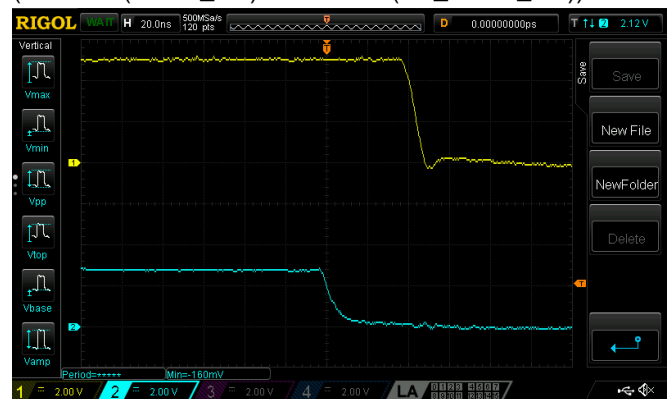(PIN# 6 (RZ_CAN0_TX) => PIN# 16 (CAN0_TX))

Channel 1 (yellow/top line) – PIN# 7 (RZ_CAN0_RX) with external 5kΩ pull up resistor
Channel 2 (light blue/2nd line) – PIN# 15 (CAN0_RX)

11. Transient from Low to High
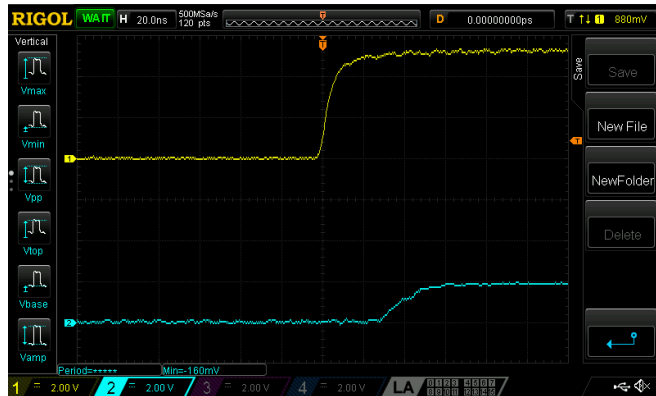(PIN# 15 (CAN0_RX) => PIN# 7 (RZ_CAN0_RX))

12. Transient from High to Low
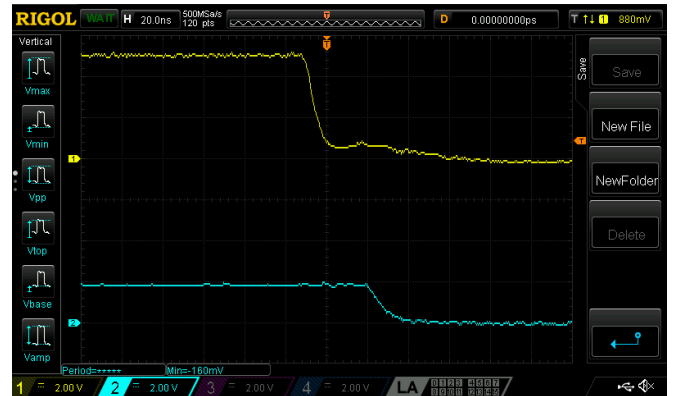(PIN# 15 (CAN0_RX) => PIN# 7 (RZ_CAN0_RX))

Channel 1 (yellow/top line) – PIN# 8 (RZ_CAN1_TX)
Channel 2 (light blue/2nd line) – PIN# 13 (CAN1_TX)

13. Transient from Low to High
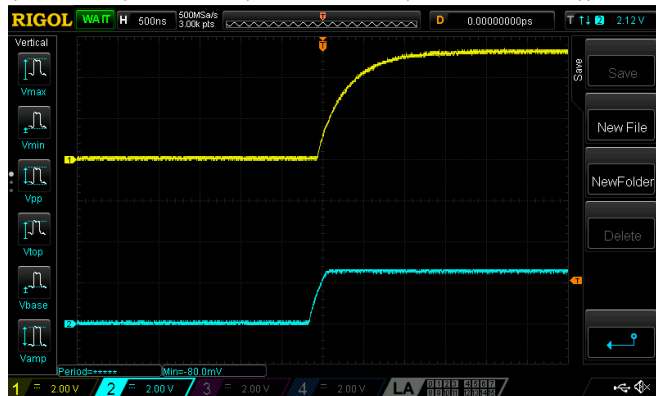(PIN# 8 (RZ_CAN1_TX) => PIN# 13 (CAN1_TX))

14. Transient from High to Low
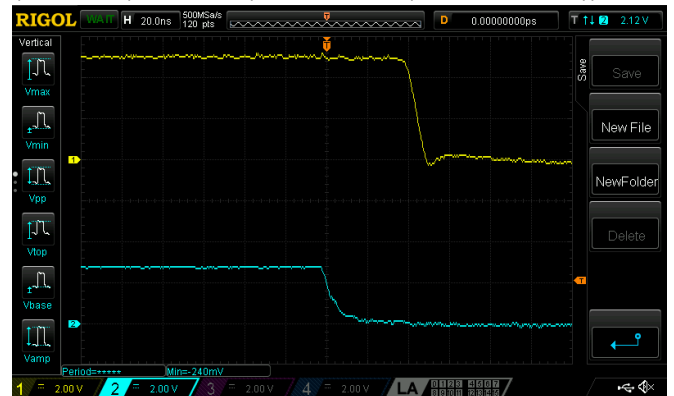(PIN# 8 (RZ_CAN1_TX) => PIN# 13 (CAN1_TX))

Channel 1 (yellow/top line) – PIN# 10 (RZ_CAN1_RX) with external 5kΩ pull up resistor
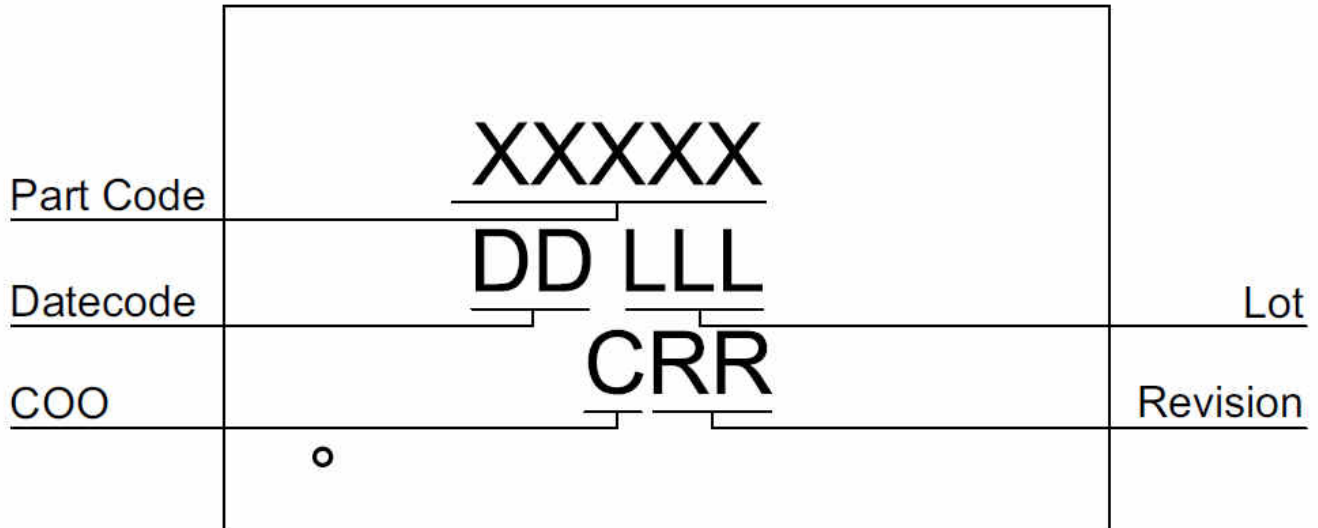Channel 2 (light blue/2nd line) – PIN# 12 (CAN1_RX)

15. Transient from Low to High
(PIN# 12 (CAN1_RX) => PIN# 10 (RZ_CAN1_RX))

16. Transient from High to Low
(PIN# 12 (CAN1_RX) => PIN# 10 (RZ_CAN1_RX))

Package Top Marking

XXXXX – Part ID Field: identifies the specific device configuration
DD   – Date Code Field: Coded date of manufacture
LLL   – Lot Code: Designates Lot #
C   – Assembly Site/COO: Specifies Assembly Site/Country of Origin
RR   – Revision Code: Device Revision

Datasheet Revision	Programming Code Number	Lock Status	Checksum	Part Code	Revision	Date
0.11	001	U	0xA06DDF4E			07/11/2023

Lock coverage for this part is indicated by √, from one of the following options:

√	Unlocked
	Locked for read, bits <1535:0>
	Locked for write, bits <1535:0>
	Locked for write all bits
	Locked for read and write bits <1535:0>
	Locked for read bits <1535:0> and write of all bits

The IC security bit is locked/set for code security for production unless otherwise specified. The Programming Code Number is not changed based on the choice of locked vs. unlocked status.

Preliminary

## Package Drawing and Dimensions

STQFN 20L 2x3mm 0.4P COL Package

JEDEC MO-220

TOP VIEW   BOTTOM VIEW   SIDE VIEW
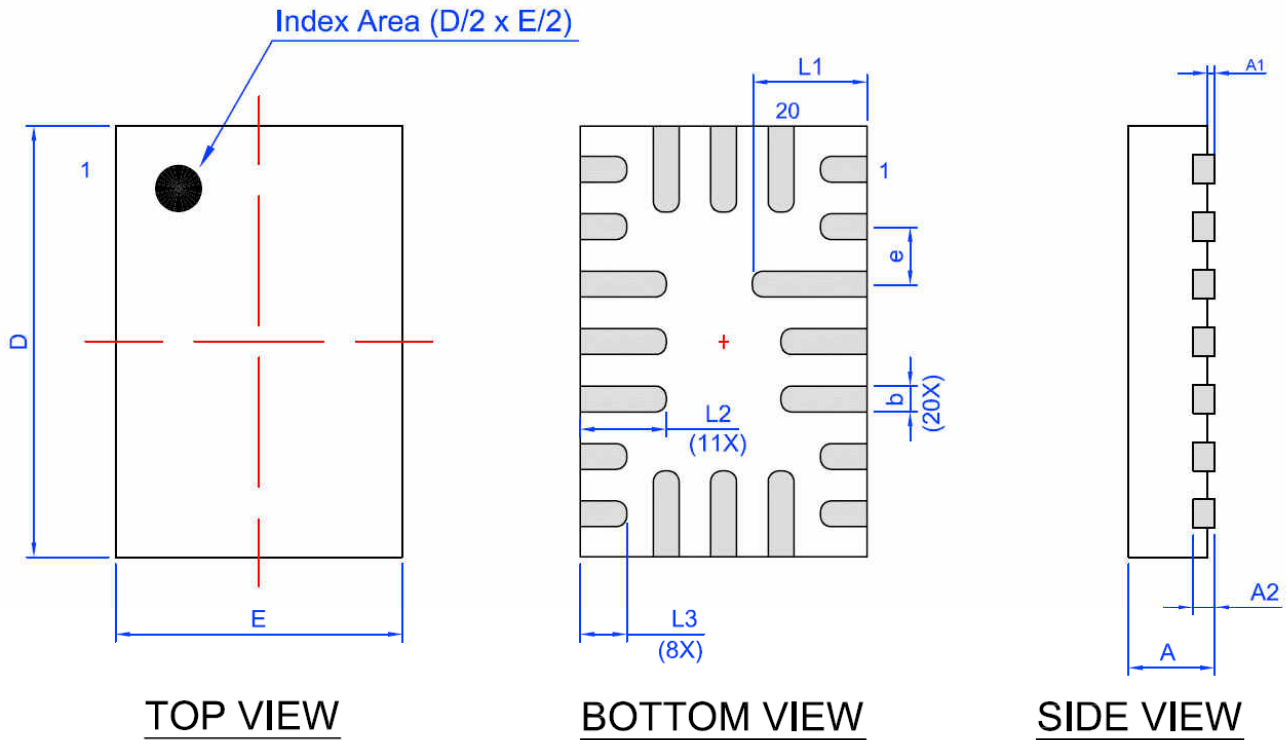
Unit: mm

Symbol	Min	Nom.	Max	Symbol	Min	Nom.	Max
A	0.50	0.55	0.60	D	2.95	3.00	3.05
A1	0.005	-	0.050	E	1.95	2.00	2.05
A2	0.10	0.15	0.20	L1	0.75	0.80	0.85
b	0.13	0.18	0.23	L2	0.55	0.60	0.65
e	0.40 BSC			L3	0.275	0.325	0.375

Tape and Reel Specification

Package Type	# of Pins	Nominal Package Size [mm]	Max Units		Reel & Hub Size [mm]	Leader (min)		Trailer (min)		Tape Width [mm]	Part Pitch [mm]
			per Reel	per Box		Pockets	Length [mm]	Pockets	Length [mm]		
STQFN 20L 2x3mm 0.4P COL	20	2x3x0.55	3000	3000	178/60	100	400	100	400	8	4

Carrier Tape Drawing and Dimensions

Package Type	Pocket BTM Length	Pocket BTM Width	Pocket Depth	Index Hole Pitch	Pocket Pitch	Index Hole Diameter	Index Hole to Tape Edge	Index Hole to Pocket Center	Tape Width
	A0	B0	K0	P0	P1	D0	E	F	W
STQFN 20L 2x3 mm 0.4P COL	2.2	3.15	0.76	4	4	1.5	1.75	3.5	8
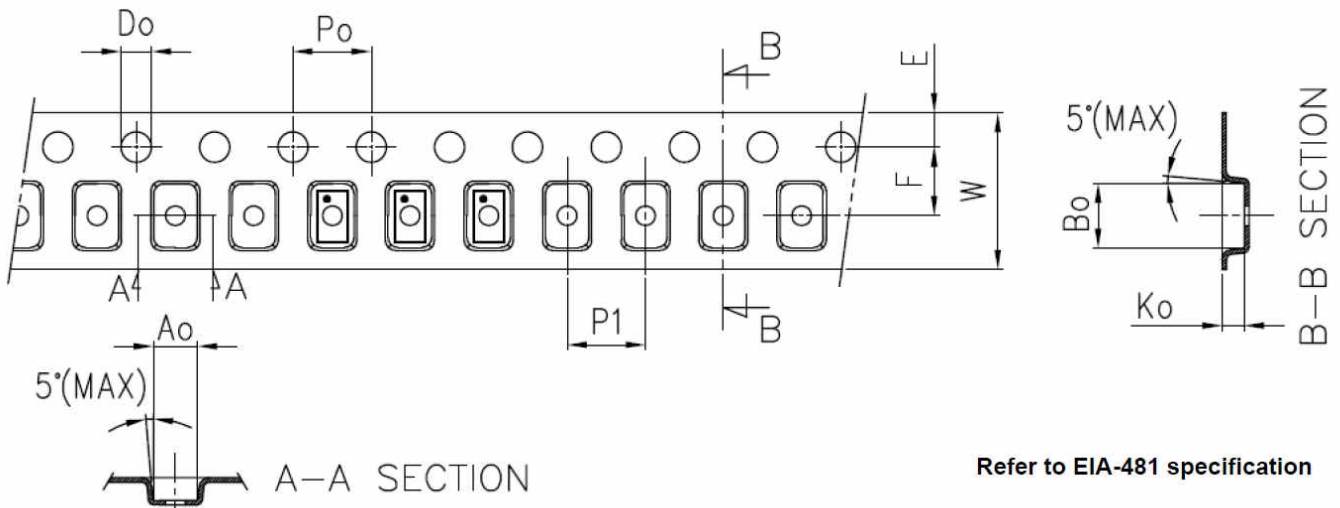
Recommended Reflow Soldering Profile

Please see IPC/JEDEC J-STD-020: latest revision for reflow profile based on package volume of 3.30 mm^3 (nominal). More information can be found at www.jedec.org.

Recommended Land Pattern

Datasheet Revision History

Date	Version	Change
10/07/2021	0.10	New design
07/11/2023	0.11	Moved to Renesas template

Preliminary

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